L Number	Hits	Search Text	DB	Time stamp
114	291	(348/126).CCLS.	USPAT;	2003/09/29 16:15
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
115	0	("114and(barorbars)").PN.	USPAT;	2003/09/29 16:15
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM TDB	
116	32	((348/126).CCLS.) and (bar or bars)	USPAT;	2003/09/29 19:47
			US-PGPUB;	
			EPO;	
			DERWENT,	
			IBM_TDB	
124	334	ault.xa. and anita.xa.	USPAT;	2003/09/29 22:11
			US-PGPUB;	
			EPO;	
i			DERWENT;	
			IBM_TDB	
126	2	(((348/126).CCLS.) and (wafer or wafers)) and (tray or trays)	USPĀT;	2003/09/29 19:48
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
125	83	((348/126).CCLS.) and (wafer or wafers)	USPĀT;	2003/09/29 19:53
			US-PGPUB,	
			EPO;	
			DERWENT,	
			IBM_TDB	
127	358	(356/237.5).CCLS.	USPAT;	2003/09/29 21:32
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
128	935	(356/400).CCLS.	USPAT;	2003/09/29 20:45
			US-PGPUB,	
			EPO;	
			DERWENT:	
			IBM_TDB	
129	0	("128andwafer").PN.	USPAT;	2003/09/29 20:45
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
130	451	((356/400).CCLS.) and wafer	USPAT;	2003/09/29 20:45
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
131	183	((((356/400).CCLS.) and wafer) and chip	USPĀT;	2003/09/29 20:46
		· - ·	US-PGPUB,]
			EPO,	
			DERWENT;	
			IBM_TDB	
132	12	((356/237.5).CCLS.) and tray	USPĀT;	2003/09/29 21:32
;		,	US-PGPUB;	
			EPO;	1
			DERWENT;	
			IBM_TDB	

1 140				
149	23	test adj l pedestal	USPAT;	2003/09/29 21:57
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
150	6	(test adj l pedestal) and wafer	USPAT;	2003/09/29 21:58
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM_TDB	
151	1317	test adj1 bar	USPAT;	2003/09/29 21:58
			US-PGPUB;	
	Ì		EPO;	}
			DERWENT;	
			IBM_TDB	
152	271	438/16.ccls. and laser	USPĀT;	2003/09/29 21:59
			US-PGPUB;	
			EPO; JPO;	
ļ			DERWENT;	
			IBM_TDB	
153	777	438/16.ccls.	USPAT;	2003/09/29 21:59
			US-PGPUB;	200000072721.37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
154	75	438/16.ccls, and camera	USPAT;	2002/00/20 22:00
'54	'3	4.30/10.ccis. and camera		2003/09/29 22:00
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
155	235901	wafer	IBM_TDB	2002/00/00 02 11
155	233901	water	USPAT;	2003/09/29 22:11
			US-PGPUB;	
			EPO;	
			DERWENT,	
150	7021		IBM_TDB	
156	7921	camera same test	USPAT;	2003/09/29 22:11
			US-PGPUB;	
	'		EPO;	
			DERWENT;	
	500		IBM_TDB	
157	532	wafer and (camera same test)	USPAT;	2003/09/29 22:11
i			US-PGPUB;	
[EPO;	
			DERWENT;	
			IBM_TDB	
158	43	(wafer and (camera same test)) and pickup	USPAT;	2003/09/29 22:26
			US-PGPUB;	
			EPO;	
			DERWENT:	
			IBM_TDB	
159	29	(wafer and (camera same test)) and boat	USPĀT;	2003/09/29 22:30
			US-PGPUB;	
			EPO;	
			DERWENT;	
			IBM TDB	
160	10	chip adj1 boat	USPAT;	2003/09/29 22:31
			US-PGPUB;	
			EPO;	
			DERWENT;	
			TBM_TDB	
				<u> </u>

-	2	6036196.pn.	USPAT;	2003/07/11 23:04
	i		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	6036196.uref,bi.	USPAT;	2003/07/11 22:33
			US-PGPUB;	
			ЕРО; ЛРО;	İ
			DERWENT;	
			IBM_TDB	
-	0	6036196.bi.	USPAT;	2003/07/11 22:33
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	Li	6036196.uref.	USPAT;	2003/07/11 22:33
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	.,	((#50555658) (#5555050) (#5540000) (#5640000)	IBM_TDB	
-	11	(("5857667") or ("5753070") or ("5749999") or ("5660380") or ("5516125") or ("5452905") or ("5375895") or ("5374829") or ("4906011") or ("4659094") or ("4603867")).PN.	USPAT	2003/07/11 22:38
-	0	324/158.ccls.	USPAT:	2003/07/11 23:07
. 11			US-PGPUB:	
	i		EPO; JPO;	
			DERWENT:	
			IBM TDB	
- 1 1	17	(438/16.ccls, and laser) and bar	USPAT:	2003/07/11 23:08
	ı	, ·	US-PGPUB,	
			ЕРО; ЛРО;	
			DERWENT:	
	}		IBM TDB	